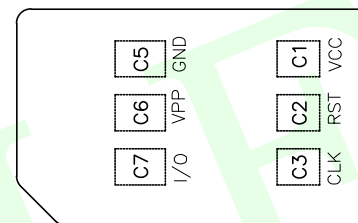
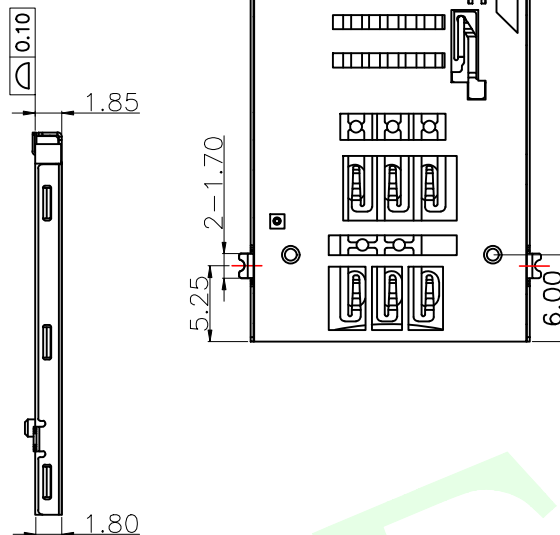
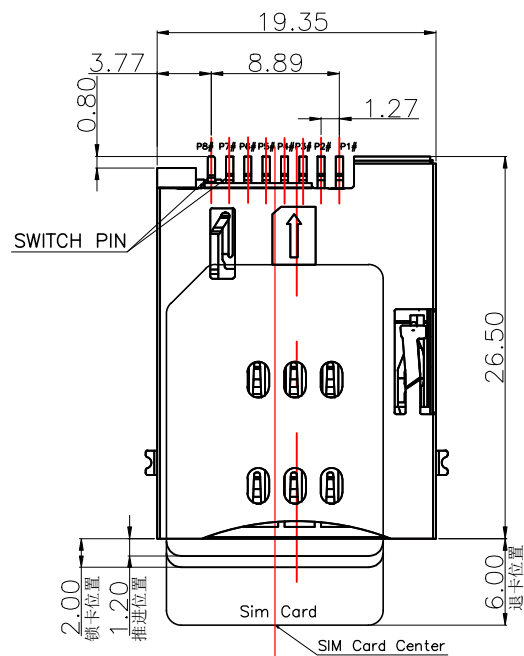
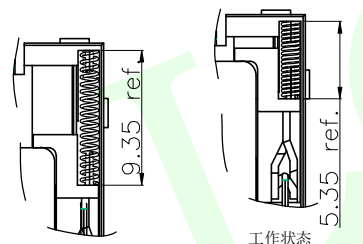
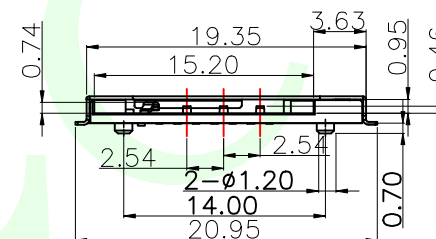


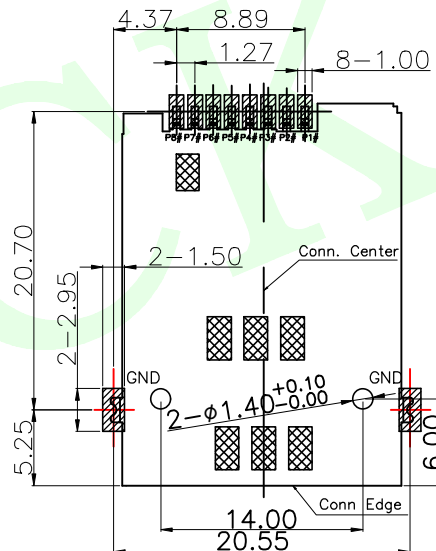
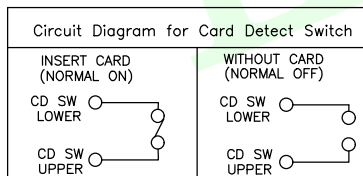
RoHS Compliant



SIM 示意图 芯片面朝下视图



工作状态



RECOMMENDED PCB LAYOUT(TOP VIEW)
GENERAL TOLERANCES:±0.05

■ SOLDER AREA
■ NONE CIRCUIT DIAGRAM AREA

PIN NO.	DESCRIPTION
P1#	C1:VCC
P2#	C5:GND
P3#	C2:RST
P4#	C6:VPP
P5#	C3:CLK
P6#	C7:I/O
P7#	POL
P8#	DET

LCK-MS -210 H180 08- Y L G

连晟欣
LCK
产品类别
MS:MINI SIM
SIM:MICRO SIM
NANO: NANO SIM
产品流水料号识别码

产品高度
H180: 1.80MM

包装方式
L: 圆盘

有柱无柱
Y: 有柱
W: 无柱

产品PIN位
08: 8PIN

电镀规格
G: gold flash
G1: 1U
G3: 3U
(以此类推)

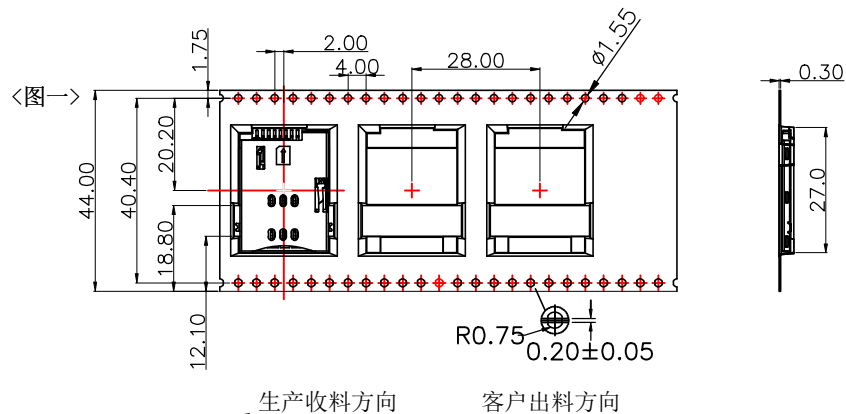
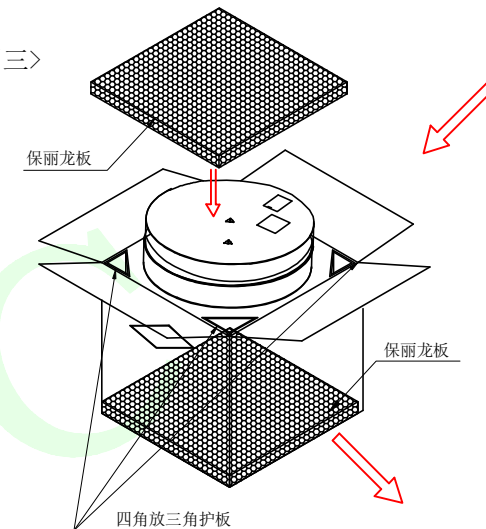
MEASURE POINT: QUADRANT POINT TANGENCY POINT INTERSECTION POINT	QP TP IP	联晟欣连接器 (深圳) 有限公司 Lianshengxin Connector (Shenzhen) Co., Ltd			
UNLESS OTHERWISE SPECIFIED, TOLERANCE:		DESIGN	Andy	DATE	2014.12.24
X. ±0.25		CHECKED		DATE	
X.x ±0.20		APPROVED		DATE	
X.xx ±0.15		PART NO:	LCK-MS-210H18008-YLG	REV:	04
ANGULAR ±3°		DRAWING NO:	102021001	SCALE:	1:1
				UNIT:	mm
				SIZE:	A4
				SHEET:	1/1

RoHS Compliant

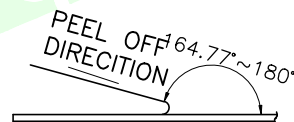
<TABLE 1> PACKAGING QUANTITY

QTY/REEL	REEL/CARTON	QTY/CARTON
550	6	3300

<图三>

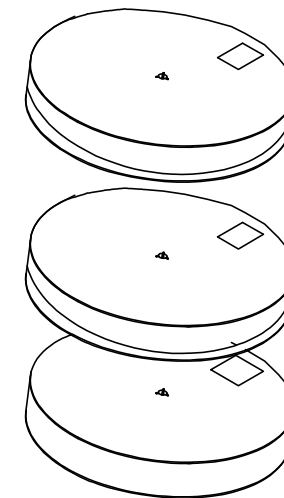


COVER TAPE PEELING FORCE: 20gf~120gf

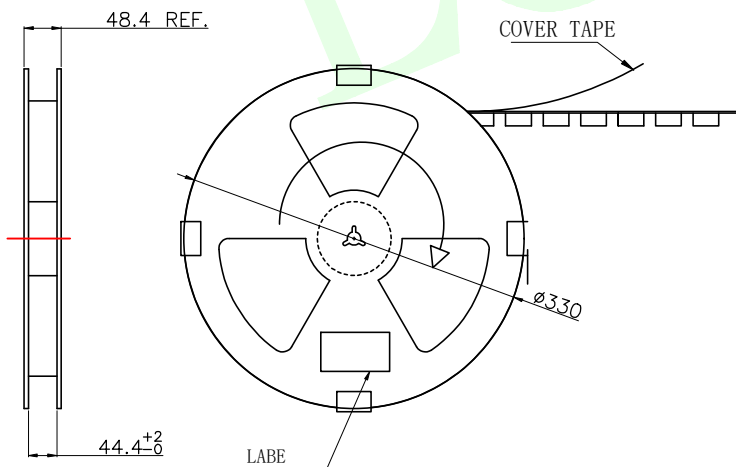


NOTE:

1. 依<图一>示放置产品于下载中, 每穴放置1PCS产品.
2. 包装机包好后, 在REEL的个等分点贴上胶带, 以防止REEL张开, 每REEL贴1PCS标签, 如<图二>示
3. 包装数量见如<TABLE 1>示
4. 包装成箱见如<图三>示
箱底放保丽龙板, 再依次将指定数量的卷装产品放入箱内, 四角分别放入四个三角护板, 最上层再放上保丽龙板.
5. 封箱, 在封好的纸箱上按客户要求写上料号, 数量等



<图二>



MEASURE POINT: QUADRANT POINT (QP) TANGENCY POINT (TP) INTERSECTION POINT (IP)		联晟欣连接器 (深圳) 有限公司 Lianshengxin Connector (Shenzhen) Co., Ltd			
UNLESS OTHERWISE SPECIFIED, TOLERANCE:		DESIGN	Andy	DATE	2014.12.24
X. ±0.25		CHECKED		DATE	
X.x ±0.20		APPROVED		DATE	
X.xx ±0.15		PART NO: LCK-MS-210H18008-YLG		REV: 04	SCALE: 1:1
ANGULAR ±3°		DRAWING NO: 102021001		UNIT: mm	
		TITLE: MINI SIM PUSH 1.8H 脚距5.25有柱		SHEET: 1/1	